

PCX755BVZFU350LE

PCX755BVZFU350LE Information

Heisener.com

Part Number PCX755BVZFU350LE

Manufacturer Microchip Technology

Category Integrated Circuits (ICs)
Embedded - Microprocessors

Description IC MPU POWERPC 350MHZ 360BGA

Package 360-BBGA Exposed Pad

For the pricing/inventory/lead time, please contact

us

For Reference Only

Website: https://www.heisener.com
E-mail: salesdept@heisener.com



Request a Quote

Certified Quality

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.









PCX755BVZFU350LE Specifications

Manufacturer Part Number	PCX755BVZFU350LE
Manufacturer	Microchip Technology
Category	Integrated Circuits (ICs)
	Embedded - Microprocessors
Package	360-BBGA Exposed Pad
Series	-
Core Processor	PowerPC
Number of Cores/Bus Width	1 Core, 32-Bit
Speed	350MHz
Co-Processors/DSP	-
RAM Controllers	-
Graphics Acceleration	No
Display & Interface Controllers	-
Ethernet	-
SATA	-
USB	-
Voltage - I/O	2.5V, 3.3V
Operating Temperature	-40°C ~ 110°C (TJ)
Security Features	-
Package / Case	360-BBGA Exposed Pad
Supplier Device Package	360-PBGA (25x25)
	Report errors?

PCX755BVZFU350LE Guarantees



Quality Guarantees

We provide 90 days warranty. *

If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.



Service Guarantees

We guarantee 100% customer satisfaction.

Our experienced sales team and tech support team back our services to satisfy all our customers.

PCX755BVZFU350LE Payment Methods



















PCX755BVZFU350LE Shipping Methods













If you have any question about PCX755BVZFU350LE, please do not hesitate to contact us!

Website: https://www.heisener.com E-mail: salesdept@heisener.com